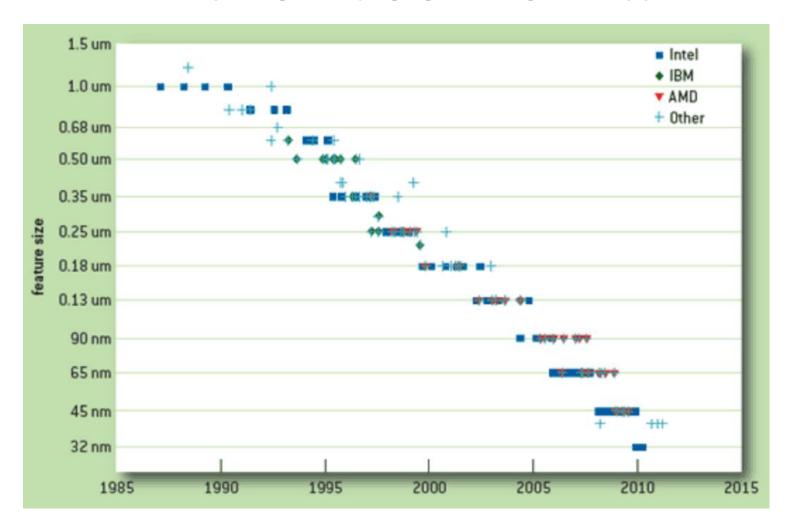
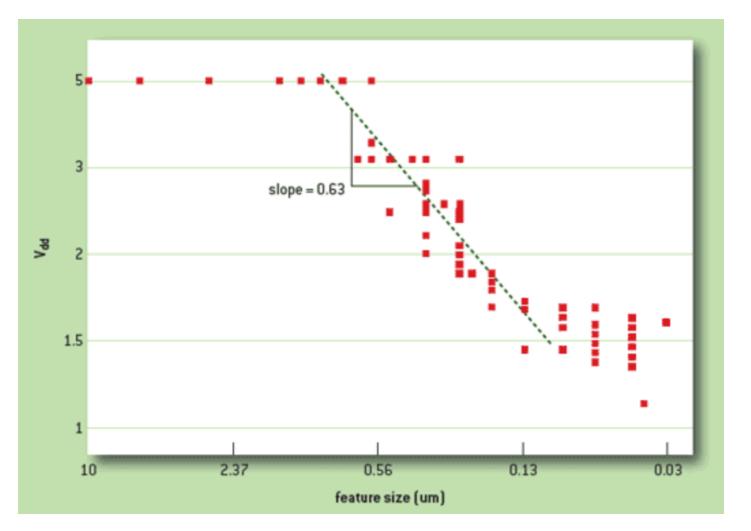


END OF MOORE'S LAW



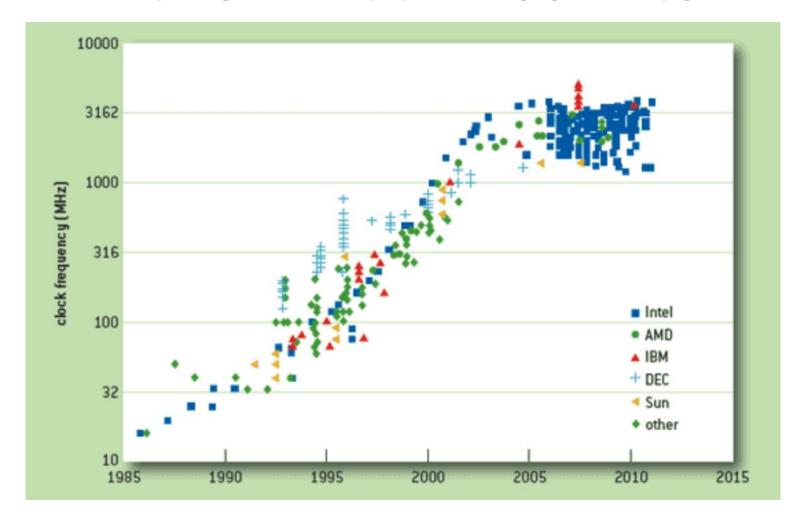
Source: acmqueue 2012/04/06 Vol 10, issue 4

VOLTAGE VS. FEATURE SIZE



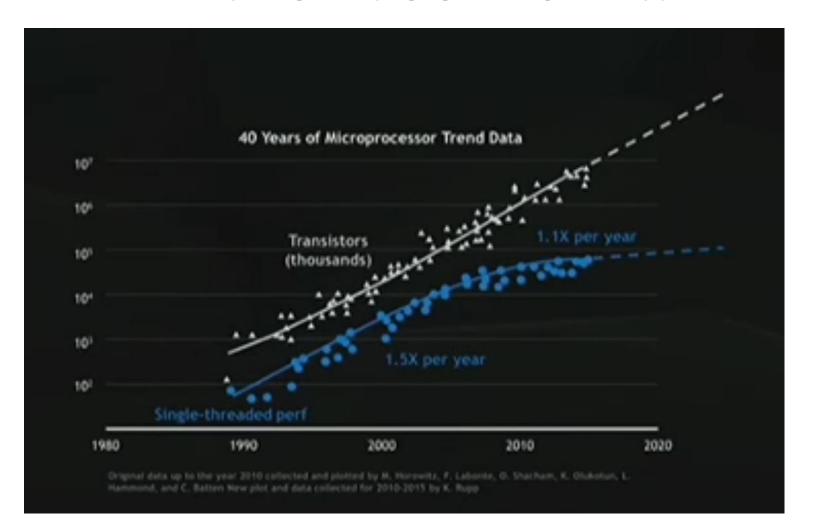
Source: acmqueue 2012/04/06 Vol 10, issue 4

END OF DENNARD SCALING

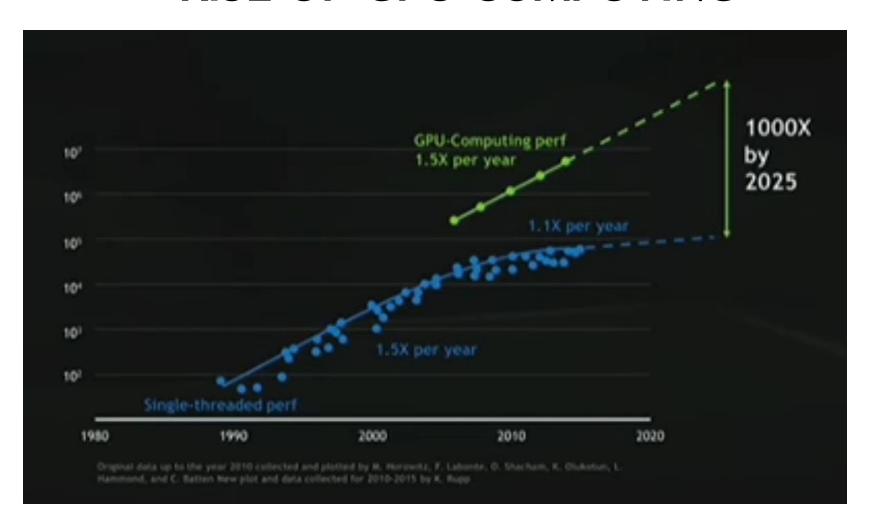


Source: acmqueue 2012/04/06 Vol 10, issue 4

END OF MOORE'S LAW



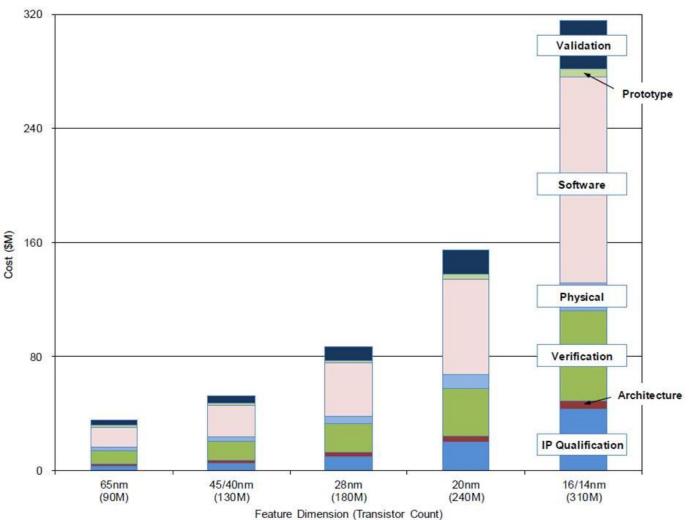
RISE OF GPU COMPUTING



SEMICONDUCTOR FEATURE SIZES

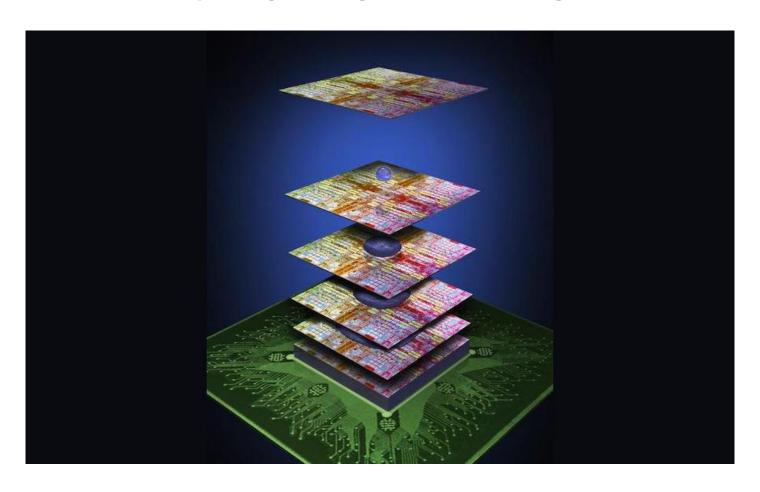
| | 32nm/28nm | 22nm/20nm | 16nm/14nm | 10nm | 7nm | 5nm |
|---------------------|-----------|-----------|-----------|------------|-------------|-------------|
| Global Foundries | 25 | NA | 17 | NA | 9.2 (2017?) | 7.1 (2019?) |
| Intel | 31 | 21 | 13 | 9.5 (2017) | 5.9 (2020) | 2023? |
| Samsung | 27 | 20 | 17 | 12 (2016) | 9.2? (2018) | 7.1 (2020?) |
| TSMC | 27 | 18 | 18 | 12 (2016) | 9.2 (2017) | 7.1 (2019?) |

COST OF EACH NEW NODE SIZE



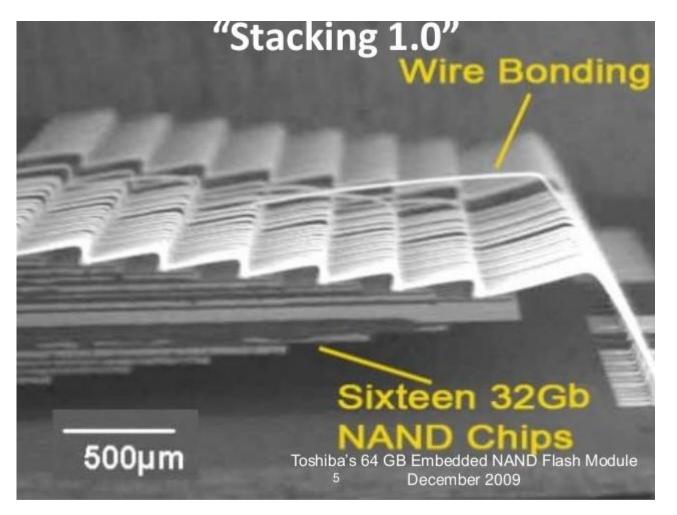
Source: Semiconductor Engineering 2014-03-17

3D STACKED DIES

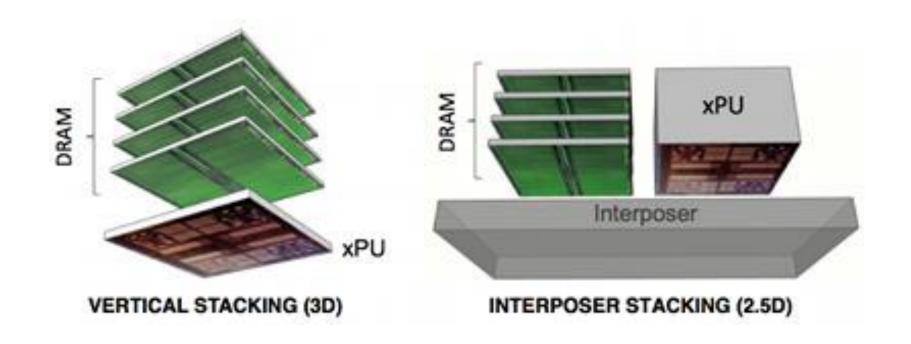


Source: IBM

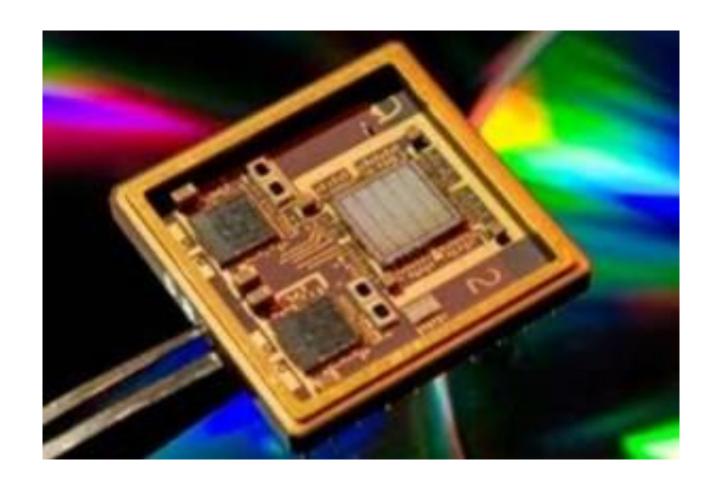
ACTUAL STACKED DIES



STACKING APPROACHES

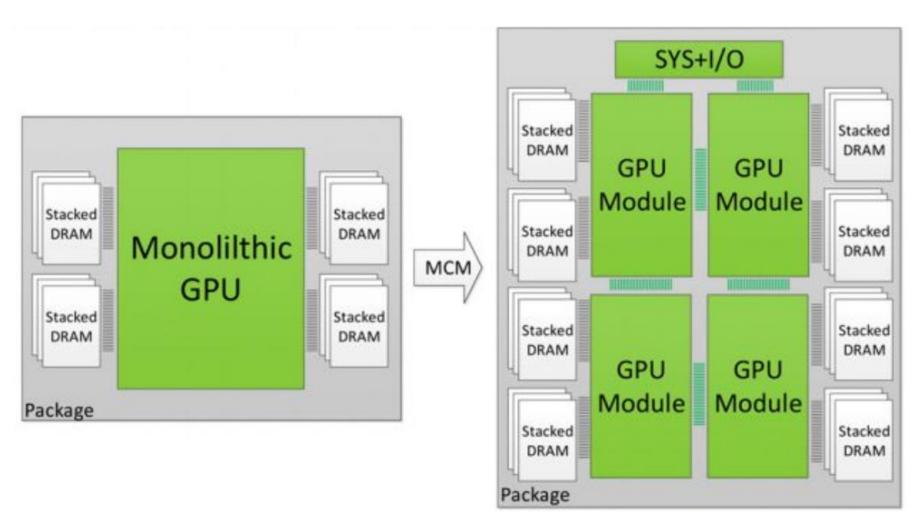


MULTI-CHIP MODULES

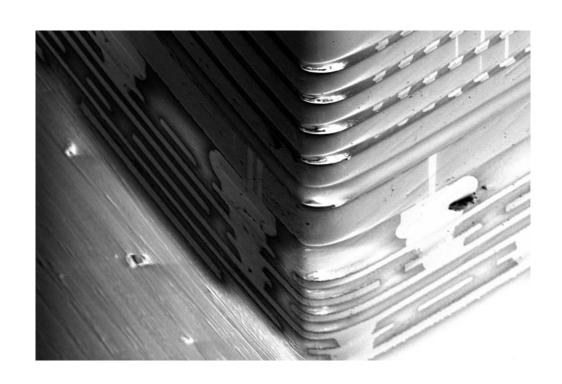


Source: ES Components Blog 2015-03-19

GPU MCM



HBM2 STACK



DENSE NODE

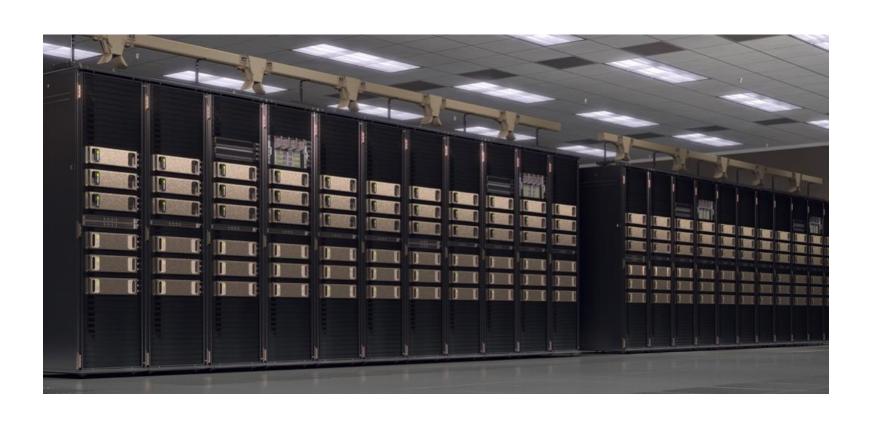


Source: Broadberry

DENSER NODE



DENSE SYSTEM



VOLTA NVLINK

300GB/sec
50% more links
28% faster signaling

